

Versatile mission computer for Vetronics & Avionics applications



■ RTCA DO & MIL-STD qualified COTS rugged modular mission computers to cut time, budget and design risk

ONYX consists of fully integrated computing subsystems ready for deployment in SWaP-C extreme environment. It allows the unit to fit easily into available nooks on any platform making it ideal for space constrained applications such as ground vehicles, manned & unmanned aircrafts, helicopters, UAS or any other robots in harsh environment requiring rock-solid reliability.

Qualified ONYX systems slash design risk, lower costs and speed deployment thanks to risk-lowering of proven technology, stress tests passed for maximum loads, saving up to \$60,000 and 2 months campaign, reducing smaller parts inventory to simplify LRU obsolescence management.

ONYX is based on modular mezzanines concept that offers customer a large flexibility and Long Life Management under revision control. It employs leading edge dual or quad-core Intel® Haswell or Skylake processing capabilities to meet a wide variety of civilian and military tactical mission programs. ONYX is ideal for high performance harsh environment/space constrained applications, and features flexible I/O which can be tailored to customer requirements, with just a few NRE allowing customer to accelerate Time-to-Market with optimized TCO.

Particularly attention has been made on reliability and thermal management. Internal I/O routing from the backplane to the front panel MIL-DTL-38999 connectors is by means of solid-state transition module. It provides cable-free higher reliability and improved signal integrity.

- > Supports Multi-Core INTEL i7 3rd, 4th and 6th Gen, evolutionary thanks to COM Express architecture with perspective of Long Life Management
- > MXC GPGPU mezzanine dedicated for powerful Graphics (DVI-D, SD/HD-SDI...), Video capture, intensive computing
- > VGA and other legacy display interfaces on demand (STANAG 3350 or analog RGBHV...)
- > H.264/AVC Encoding and streaming capabilities
- > PMC and mini PCI Express sites for flexible I/O expansion and Wireless functions

- > Cable-free, Fan less, MIL-DTL-38999 circular connectors
- > Real cold start at -40°C and up to +71°C Operating Temp (depend on configuration and cooling system)
- > Standard BOM Qualified MIL-STD-810G/461F/1275D/704/D0-160F
- > IP-67 Ingress
- > High flexibility to Modified COTS Services (functions & connectors)
- > ITAR free without Export Control



System	specif	ficati	ons

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rocessor Module	COM-Express Basic Size
Processor 6 th Generation Intel	Mobile 6 th Generation Intel® Xeon® and Core™ Processors - 14nm ("Skylake-H")
	Xeon® E3-1505L v5 2.0/2.8GHz (Turbo), 0.35-1.0GHz (Graphics), 8M, 25W (4C/GT2)
	Core™ i7-6822EQ 2.0/2.8GHz (Turbo), 0.35-1.0GHz (Graphics), 8M, 25W (4C/GT2)
Memory	Dual channel 1867/2133 MHz DDR4 memory up to 32GB
Processor 4 th Generation Intel	4 th Generation Intel® Core™ i7 Processors (Mobile) - 22nm ("Haswell")

i7-4860EQ 2.4 GHz (3.2 GHz Turbo), 47W (4C/GT3) i5-4400E 2.7 GHz (3.3 GHz Turbo), 37W (2C/GT2) i5-4402E 1.6 GHz (2.7 GHz Turbo), 25W (2C/GT2)

Memory Dual channel with ECC 1600/1333 MHz DDR3L memory up to 16GB

Processor 3rd Generation Intel 3rd Generation Intel® Core™ i7/i3, 22nm process, ("Ivy Bridge")

i7-3612QE 2.1GHz, 6MB L3 cache, 35W, quad core i7-3555LE 2.5GHz, 4MB L3 cache, 25W, dual core i7-3517UE 1.7GHz, 4MB L3 cache, 17W, dual core

Memory Dual channel ECC 1600 MHz DDR3 memory up to 16 GB

 Video outputs (Intel HD Graphic)
 1x VGA* + 1x DVI-D Single Link

 Other video Inputs / Outputs
 Using MXC or miniPCIe cards

 Ethernet
 3x 10/100/1000 BaseT

Serial 4x RS232/RS422/RS485 (software configurable)

USB 2.0 4x USB2.0 High / Full / Low speed

USB 3.0 (38999 USB Field) With miniPCle card. Limited to 250MBytes /sec, on rear panel

Audio Intel® High Def Audio: 1x In and 1x Out Lines

Discret I/O 8x GPIO LV TTL - Reset, Power Button, Power Led, HDD Led, Fast Erase

GP-GPU Expansion slot 1x MXC site available
Solid State Disk (SSD) (Internal) 1x SSD 2.5" slot (MLC or SLC) - 1x cFast slot (MLC or SLC)
Hardware monitoring Voltages, CPU, GPU, and carrier board temperatures

Watchdog timer Programmable timer range to generate RESET





A: Power supply
B: USB, Serial, GPIO,
DVI-D + VGA
C: Ethernet, Audio

D: GPGPU I/O E: PMC I/O's F: Ground

Power supply

Power Input +28VDC (+10VDC up to +36VDC)
Hold-up capacitors for momentary power interruption protection (approx 120ms)

MIL-STD-1275D / DO-160F / MIL-STD-461F / MIL-STD-704

Power consumption Less than 90W

SWaP-C constraints

 Size (WxDxH)
 270mm x 250mm x 88mm (2U)

 Weight
 7kg

 Cooling type
 Convection & radiation by fins, conduction by cold plate (conduction cooled inside)

 Connectors
 Military circular IP67 locking connectors (MIL-DTL-38999)
 Front panel customizable for specific application

Environmental Qualification Tests

Operating temperature	-40°C / +71°C (depend on configuration and cooling system)	Salt fog	50% salt spray / 96h (D0-160F)	
Storage temperature	Storage: -40°C / +85°C	Dust	Wind and fine dust particles (DO-160F)	
Ingress protection rating	IP67	Operating shock & vibration	MIL-STD-810G / DO-160F	
Altitude	Up to 15000 feet (DO-160F)	EMI / RFI	MIL-STD-461F / DO-160F	
Humidity	0%-95% relative humidity (D0-160F)	CE certification	EMC: 2014/30/UE; EN 61000-6-2, EN55022, EN 55024 - SAFETY: 2014/35/UE; EN60950-1: 2006 2 nd edition A11: 2009 + A1: 2010 + A12: 2011 + A2: 2014	

Software corner

Operating system Windows 7 32/64-bit, Linux 32/64-bit, PikeOS. For other requirements, contact ECRIN Systems

Security & dependability

Trusted platform module Atmel AT97SC3204; TPM 1.2/2.0 (TPM 2.0 release later)

Built-In-Test pBIT, monitoring functions library, Maintenance L2 with SEMA library

Export control classification

ITAR Free - Not Controlled (ECCN 4A003)

Other specifications

Reliability

Designed and manufactured using ISO 9001:2000 Certified Quality Program

Calculated per MIL-HDBK-217F, available upon request

Regulatory compliance
European CE Mark

Warranty

1 year return to depot warranty (extended warranty available with service contract)

Starter cable set

Optional starter breakout cable set mates with MIL-DTL-38999 connectors to break out standard CPU I/O and power signals to traditional PC style interfaces for lab or bench testing purposes

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^{*} Not available with Skylake processor